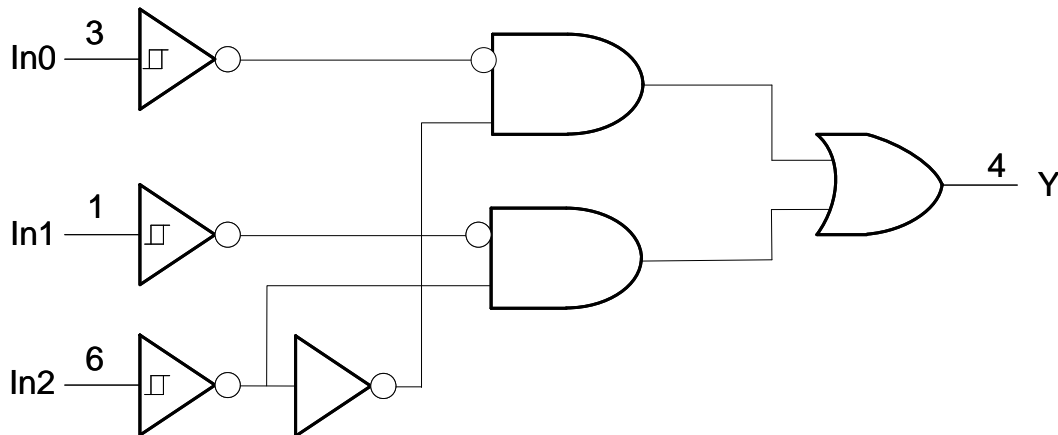


Pin Descriptions

| Pin Name | Description |
|-----------------|----------------|
| IN1 | Data Input |
| GND | Ground |
| IN0 | Data Input |
| Y | Data Output |
| V _{CC} | Supply Voltage |
| IN2 | Data Input |

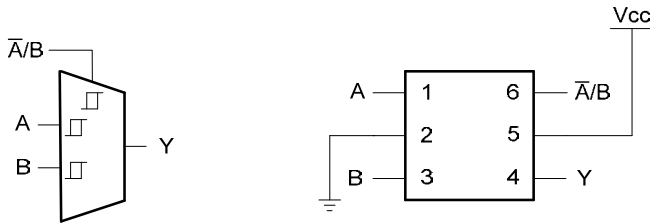
Logic Diagram



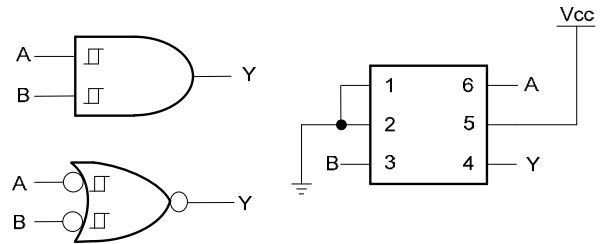
Function Table

| Inputs | | | Output |
|--------|-----|-----|--------|
| IN2 | IN1 | IN0 | Y |
| L | L | L | L |
| L | L | H | L |
| L | H | L | H |
| L | H | H | H |
| H | L | L | L |
| H | L | H | H |
| H | H | L | L |
| H | H | H | H |

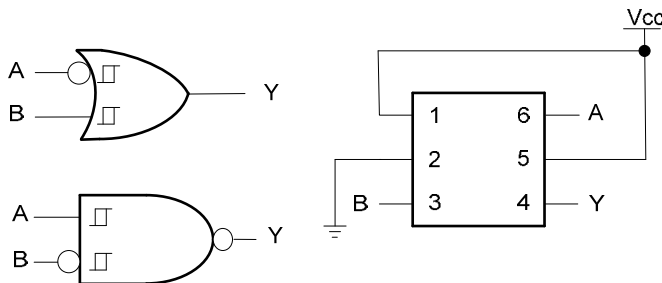
Logic Configurations



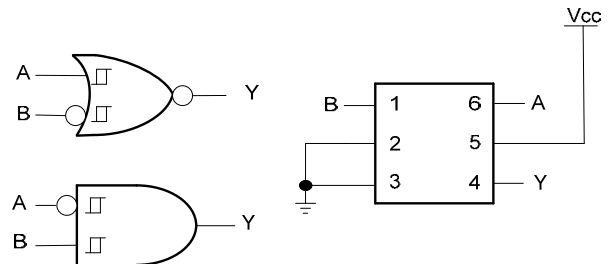
Configuration 1
2 to 1 Data Selector



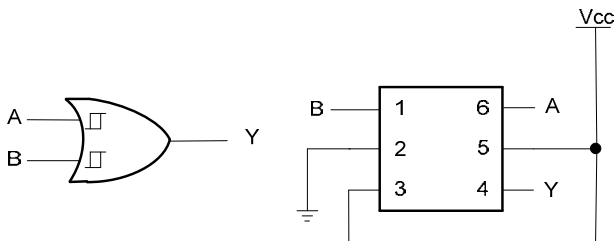
Configuration 2
2-Input AND Gate
2-Input NOR Gate with Both Inputs Inverted



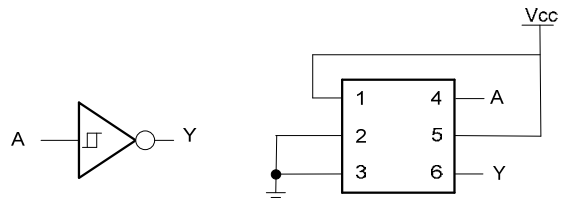
Configuration 3
2-Input NAND Gate with B Input Inverted
2-Input OR Gate with A Input Inverted



Configuration 4
2-Input NOR Gate with One Input Inverted
2-Input AND Gate with One Input Inverted



Configuration 5
2-Input OR Gate



Configuration 6
Inverter

| Function Selection Table | |
|---------------------------------------|---------------|
| Logic Function | Configuration |
| 2-to-1 Data Selector | 1 |
| 2-input AND gate | 2 |
| 2-input AND with inverted input | 3, 4 |
| 2-input NOR with inverted input | 3, 4 |
| 2-input OR | 5 |
| 2-input NOR with both inputs inverted | 2 |
| 1-input Inverter | 6 |

Absolute Maximum Ratings (Note 4)

| Symbol | Description | Rating | Unit |
|------------------|---|-------------------------------|------|
| ESD HBM | Human Body Model ESD Protection | 2 | KV |
| ESD MM | Machine Model ESD Protection | 200 | V |
| V _{CC} | Supply Voltage Range | -0.5 to 6.5 | V |
| V _I | Input Voltage Range | -0.5 to 6.5 | V |
| V _O | Voltage applied to output in high impedance or I _{OFF} state | -0.5 to 6.5 | V |
| V _O | Voltage applied to output in high or low state | -0.3 to V _{CC} + 0.5 | V |
| I _{IK} | Input Clamp Current V _I < 0 | -50 | mA |
| I _{OK} | Output Clamp Current | -50 | mA |
| I _O | Continuous output current | ±50 | mA |
| | Continuous current through V _{DD} or GND | ±100 | mA |
| T _J | Operating Junction Temperature | -40 to +150 | °C |
| T _{STG} | Storage Temperature | -65 to +150 | °C |

Notes: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

Recommended Operating Conditions (Note 5)

| Symbol | Parameter | Min | Max | Unit |
|-----------------|------------------------------------|---|-----------------|------|
| V _{CC} | Operating Voltage | 1.65 | 5.5 | V |
| | | 1.5 | | V |
| V _I | Input Voltage | 0 | 5.5 | V |
| V _O | Output Voltage | 0 | V _{CC} | V |
| I _{OH} | High-level output current | V _{CC} = 1.65V | -4 | mA |
| | | V _{CC} = 2.3V | -8 | |
| | | V _{CC} = 3V | -16 | |
| | | | -24 | |
| | | V _{CC} = 4.5V | -32 | |
| I _{OL} | Low-level output current | V _{CC} = 1.65V | 4 | mA |
| | | V _{CC} = 2.3V | 8 | |
| | | V _{CC} = 3V | 16 | |
| | | | 24 | |
| | | V _{CC} = 4.5V | 32 | |
| Δt/ΔV | Input transition rise or fall rate | V _{CC} = 1.8V ± 0.15V, 2.5V ± 0.2V | 20 | ns/V |
| | | V _{CC} = 3.3V ± 0.3V | 10 | |
| | | V _{CC} = 5V ± 0.5V | 5 | |
| T _A | Operating free-air temperature | -40 | +125 | °C |

Notes: 5. Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ (All typical values are at $V_{CC} = 3.3\text{V}$, $T_A = +25^\circ\text{C}$)

| Symbol | Parameter | Test Conditions | V_{CC} | Min | Typ | Max | Unit |
|-----------------|--|--|---------------|----------------|-----|----------|---------------|
| V_{T+} | Positive-going input threshold voltage | | 1.65V | 0.70 | | 1.20 | |
| | | | 2.3V | 1.11 | | 1.60 | |
| | | | 3V | 1.50 | | 2.00 | |
| | | | 4.5V | 2.16 | | 2.74 | |
| | | | 5.5V | 2.61 | | 3.33 | |
| V_{T-} | Negative-going input threshold voltage | | 1.65V | 0.30 | | 0.72 | |
| | | | 2.3V | 0.58 | | 1.00 | |
| | | | 3V | 0.80 | | 1.30 | |
| | | | 4.5V | 1.21 | | 1.95 | |
| | | | 5.5V | 1.45 | | 2.35 | |
| ΔV_T | Hysteresis ($V_{T+} - V_{T-}$) | | 1.65V | 0.30 | | 0.62 | |
| | | | 2.3V | 0.40 | | 0.80 | |
| | | | 3V | 0.35 | | 1.00 | |
| | | | 4.5V | 0.55 | | 1.10 | |
| | | | 5.5V | 0.60 | | 1.20 | |
| V_{OH} | High Level Output Voltage | $I_{OH} = -100\mu\text{A}$ | 1.65V to 5.5V | $V_{CC} - 0.1$ | | | V |
| | | $I_{OH} = -4\text{mA}$ | 1.65V | 1.2 | | | |
| | | $I_{OH} = -8\text{mA}$ | 2.3V | 1.9 | | | |
| | | $I_{OH} = -16\text{mA}$ | 3V | 2.4 | | | |
| | | $I_{OH} = -24\text{mA}$ | | 2.3 | | | |
| | | $I_{OH} = -32\text{mA}$ | 4.5V | 3.8 | | | |
| V_{OL} | High-level Input Voltage | $I_{OL} = 100\mu\text{A}$ | 1.65V to 5.5V | | | 0.1 | V |
| | | $I_{OL} = 4\text{mA}$ | 1.65V | | | 0.45 | |
| | | $I_{OL} = 8\text{mA}$ | 2.3V | | | 0.3 | |
| | | $I_{OL} = 16\text{mA}$ | 3V | | | 0.4 | |
| | | $I_{OL} = 24\text{mA}$ | | | | 0.55 | |
| | | $I_{OL} = 32\text{mA}$ | 4.5V | | | 0.55 | |
| I_I | Input Current | $V_I = 5.5\text{V}$ or GND | 0 to 5.5V | | | ± 5 | μA |
| I_{OFF} | Power Down Leakage Current | V_I or $V_O = 5.5\text{V}$ | 0 | | | ± 10 | μA |
| I_{CC} | Supply Current | $V_I = 5.5\text{V}$ of GND $I_O = 0$ | 1.65V to 5.5V | | | 10 | μA |
| ΔI_{CC} | Additional Supply Current | One input at $V_{CC} - 0.6\text{V}$ Other inputs at V_{CC} or GND | 3V to 5.5V | | | 500 | μA |

Electrical Characteristics $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$ (All typical values are at $V_{CC} = 3.3\text{V}$, $T_A = +25^\circ\text{C}$)

| Symbol | Parameter | Test Conditions | V_{CC} | Min | Typ | Max | Unit |
|-----------------|--|--|---------------|----------------|-----|-----------|---------------|
| V_{T+} | Positive-going input threshold voltage | | 1.65V | 0.70 | | 1.20 | |
| | | | 2.3V | 1.11 | | 1.60 | |
| | | | 3V | 1.50 | | 2.00 | |
| | | | 4.5V | 2.16 | | 2.74 | |
| | | | 5.5V | 2.61 | | 3.33 | |
| V_{T-} | Negative-going input threshold voltage | | 1.65V | 0.30 | | 0.75 | |
| | | | 2.3V | 0.58 | | 1.03 | |
| | | | 3V | 0.80 | | 1.33 | |
| | | | 4.5V | 1.21 | | 1.95 | |
| | | | 5.5V | 1.45 | | 2.35 | |
| ΔV_T | Hysteresis ($V_{T+} - V_{T-}$) | | 1.65V | 0.30 | | 0.62 | |
| | | | 2.3V | 0.37 | | 0.80 | |
| | | | 3V | 0.32 | | 1.00 | |
| | | | 4.5V | 0.50 | | 1.20 | |
| | | | 5.5V | 0.55 | | 1.40 | |
| V_{OH} | High Level Output Voltage | $I_{OH} = -100\mu\text{A}$ | 1.65V to 5.5V | $V_{CC} - 0.1$ | | | V |
| | | $I_{OH} = -4\text{mA}$ | 1.65V | 0.95 | | | |
| | | $I_{OH} = -8\text{mA}$ | 2.3V | 1.7 | | | |
| | | $I_{OH} = -16\text{mA}$ | 3V | 1.9 | | | |
| | | $I_{OH} = -24\text{mA}$ | | 2.0 | | | |
| | | $I_{OH} = -32\text{mA}$ | 4.5V | 3.4 | | | |
| V_{OL} | High-level Input Voltage | $I_{OL} = 100\mu\text{A}$ | 1.65V to 5.5V | | | 0.1 | V |
| | | $I_{OL} = 4\text{mA}$ | 1.65V | | | 0.7 | |
| | | $I_{OL} = 8\text{mA}$ | 2.3V | | | 0.45 | |
| | | $I_{OL} = 16\text{mA}$ | 3V | | | 0.6 | |
| | | $I_{OL} = 24\text{mA}$ | | | | 0.8 | |
| | | $I_{OL} = 32\text{mA}$ | 4.5V | | | 0.8 | |
| I_I | Input Current | $V_I = 5.5\text{V}$ or GND | 0 to 5.5V | | | ± 100 | μA |
| I_{OFF} | Power Down Leakage Current | V_I or $V_O = 5.5\text{V}$ | 0 | | | ± 200 | μA |
| I_{CC} | Supply Current | $V_I = 5.5\text{V}$ of GND $I_O = 0$ | 1.65V to 5.5V | | | 200 | μA |
| ΔI_{CC} | Additional Supply Current | One input at $V_{CC} - 0.6\text{V}$ Other inputs at V_{CC} or GND | 3V to 5.5V | | | 5000 | μA |

Electrical Characteristics (All typical values are at $V_{CC} = 3.3V$, $T_A = +25^\circ C$)

| Symbol | Parameter | Test Conditions | V_{CC} | Min | Typ | Max | Unit |
|---------------|--|--------------------------------|----------|-----|-----|-----|--------------|
| C_I | Input Capacitance | $V_I = V_{CC} - \text{or GND}$ | 3.3 | | 3.5 | | pF |
| θ_{JA} | Thermal Resistance Junction-to-Ambient | SOT26 | (Note 6) | | 204 | | $^\circ C/W$ |
| | | SOT363 | | | 371 | | |
| | | X2-DFN1410-6 | | | 430 | | |
| | | X2-DFN1010-6 | | | 510 | | |
| θ_{JC} | Thermal Resistance Junction-to-Case | SOT26 | (Note 6) | | 52 | | $^\circ C/W$ |
| | | SOT363 | | | 143 | | |
| | | X2-DFN1410-6 | | | 190 | | |
| | | X2-DFN1010-6 | | | 250 | | |

Notes: 6. Test condition for SOT26, SOT363, X2-DFN1410-6 and X2-DFN1010-6 : Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Switching Characteristics

$T_A = -40^\circ C$ to $+85^\circ C$, $C_L = 30$ or $50pF$ as noted (see Figure 1)

| Parameter | From (Input) | TO (OUTPUT) | $V_{CC} = 1.8V \pm 0.15V$ | | $V_{CC} = 2.5V \pm 0.2V$ | | $V_{CC} = 3.3V \pm 0.3V$ | | $V_{CC} = 5V \pm 0.5V$ | | Unit |
|-----------|--------------|-------------|---------------------------|------|--------------------------|-----|--------------------------|-----|------------------------|-----|------|
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t_{pd} | Any | Y | 1.0 | 14.4 | 0.7 | 8.3 | 0.7 | 6.3 | 0.7 | 5.1 | ns |

$T_A = -40^\circ C$ to $+125^\circ C$, $C_L = 30$ or $50pF$ as noted (see Figure 1)

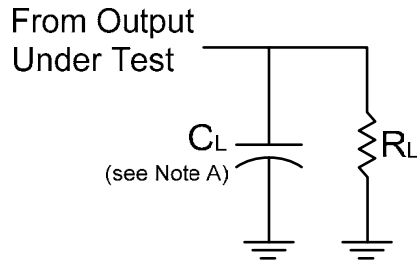
| Parameter | From (Input) | TO (OUTPUT) | $V_{CC} = 1.8V \pm 0.15V$ | | $V_{CC} = 2.5V \pm 0.2V$ | | $V_{CC} = 3.3V \pm 0.3V$ | | $V_{CC} = 5V \pm 0.5V$ | | Unit |
|-----------|--------------|-------------|---------------------------|------|--------------------------|------|--------------------------|-----|------------------------|-----|------|
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t_{pd} | Any | Y | 1.0 | 18.0 | 0.7 | 10.4 | 0.7 | 7.9 | 0.7 | 6.4 | ns |

Operating Characteristics

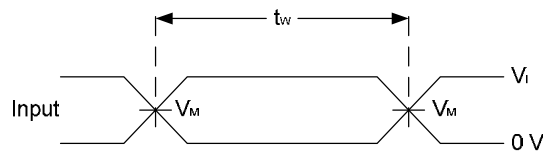
$T_A = +25^\circ C$

| Parameter | Test Conditions | $V_{CC} = 1.8V$ | $V_{CC} = 2.5V$ | $V_{CC} = 3.3V$ | $V_{CC} = 5V$ | Unit |
|-----------|---|-----------------|-----------------|-----------------|---------------|------|
| | | Typ. | Typ. | Typ. | Typ. | |
| C_{pd} | Power dissipation capacitance $f = 10 \text{ MHz}$ | 22 | 22 | 23 | 24 | pF |

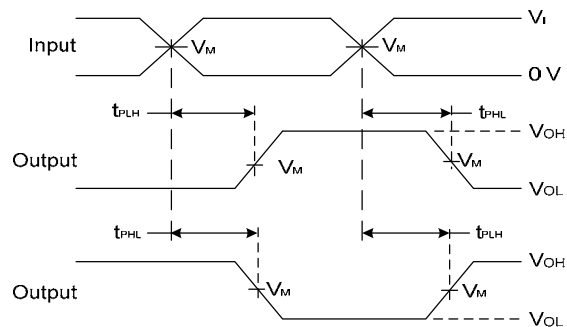
Parameter Measurement Information



| V_{CC} | Inputs | | V_M | C_L | R_L |
|------------------|----------|--------------|------------|-------|--------------|
| | V_I | t_r/t_f | | | |
| $1.8V \pm 0.15V$ | V_{CC} | $\leq 2ns$ | $V_{CC}/2$ | 30pF | 1K Ω |
| $2.5V \pm 0.2V$ | V_{CC} | $\leq 2ns$ | $V_{CC}/2$ | 30pF | 500 Ω |
| $3.3V \pm 0.3V$ | 3V | $\leq 2.5ns$ | 1.5V | 50pF | 500 Ω |
| $5V \pm 0.5V$ | V_{CC} | $\leq 2.5ns$ | $V_{CC}/2$ | 50pF | 500 Ω |



**Voltage Waveform
Pulse Duration**

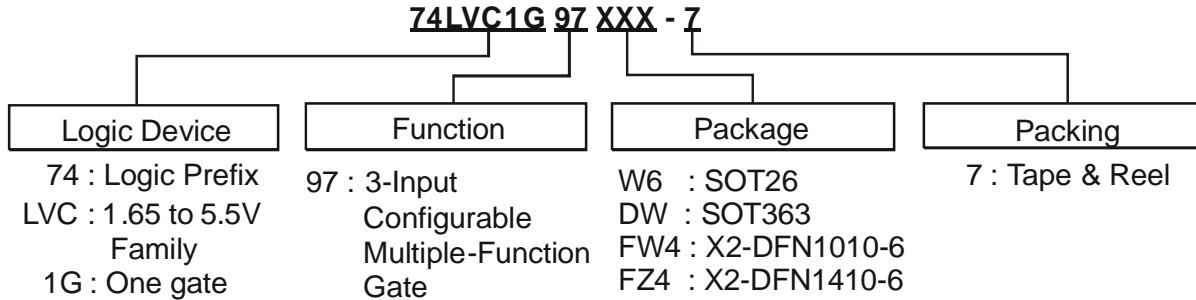






**Voltage Waveform
Propagation Delay Times
Inverting and Non Inverting Outputs**

Figure 1. Load Circuit and Voltage Waveforms

- Notes:
- A. Includes test lead and test apparatus capacitance.
 - B. All pulses are supplied at pulse repetition rate ≤ 10 MHz
 - C. Inputs are measured separately one transition per measurement
 - D. t_{PLH} and t_{PHL} are the same as t_{PD}

Ordering Information

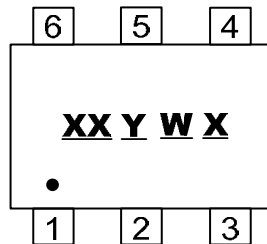


| | Device | Package Code | Packaging (Note 7) | 7" Tape and Reel | |
|---|----------------|--------------|-----------------------|------------------|--------------------|
| | | | | Quantity | Part Number Suffix |
|  | 74LVC1G97W6-7 | W6 | SOT26 | 3000/Tape & Reel | -7 |
|  | 74LVC1G97DW-7 | DW | SOT363 | 3000/Tape & Reel | -7 |
|  | 74LVC1G97FW4-7 | FW4 | X2-DFN1010-6 | 5000/Tape & Reel | -7 |
|  | 74LVC1G97FZ4-7 | FZ4 | X2-DFN1410-6 | 5000/Tape & Reel | -7 |

Notes: 7. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

Marking Information

(1) SOT26, SOT363

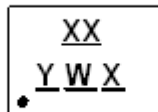


XX : Identification code
Y : Year 0~9
W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents
52 and 53 week
X : A~Z : Internal Code

| Part Number | Package | Identification Code |
|-------------|---------|---------------------|
| 74LVC1G97W6 | SOT26 | TY |
| 74LVC1G97DW | SOT363 | TY |

(2) X2-DFN1010-6, X2-DFN1410-6

(Top View)

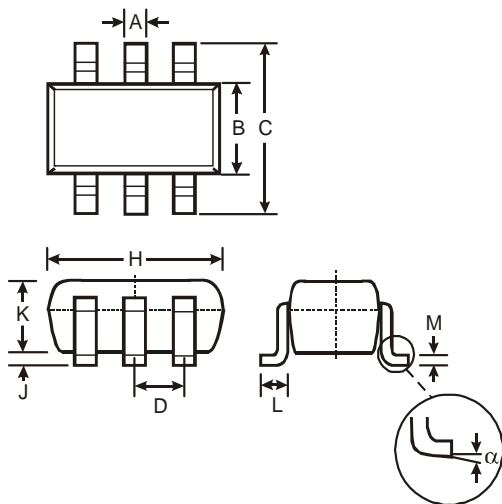


XX : Identification Code
Y : Year : 0~9
W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents
52 and 53 week
X : A~Z : Internal code

| Part Number | Package | Identification Code |
|--------------|--------------|---------------------|
| 74LVC1G97FW4 | X2-DFN1010-6 | TY |
| 74LVC1G97FZ4 | X2-DFN1410-6 | TY |

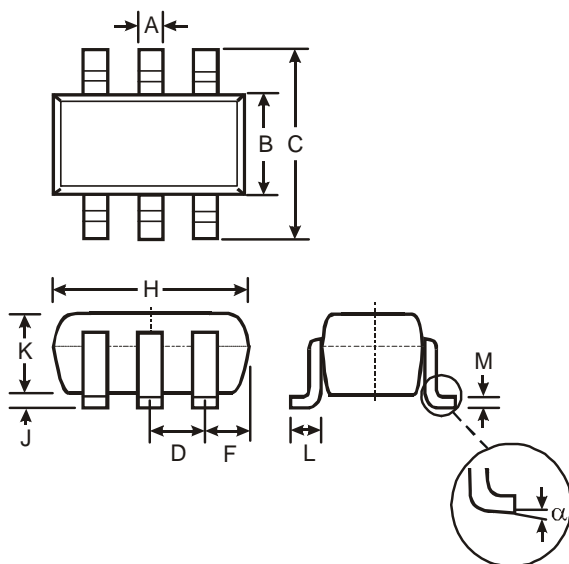
Package Outline Dimensions (All Dimensions in mm)

(1) SOT26



| SOT26 | | | |
|----------------------|-------|------|------|
| Dim | Min | Max | Typ |
| A | 0.35 | 0.50 | 0.38 |
| B | 1.50 | 1.70 | 1.60 |
| C | 2.70 | 3.00 | 2.80 |
| D | — | — | 0.95 |
| H | 2.90 | 3.10 | 3.00 |
| J | 0.013 | 0.10 | 0.05 |
| K | 1.00 | 1.30 | 1.10 |
| L | 0.35 | 0.55 | 0.40 |
| M | 0.10 | 0.20 | 0.15 |
| α | 0° | 8° | — |
| All Dimensions in mm | | | |

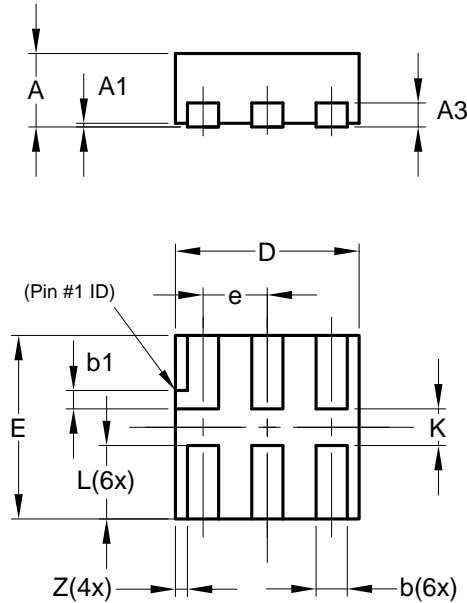
(2) SOT363



| SOT363 | | |
|----------------------|----------|------|
| Dim | Min | Max |
| A | 0.10 | 0.30 |
| B | 1.15 | 1.35 |
| C | 2.00 | 2.20 |
| D | 0.65 Typ | |
| F | 0.40 | 0.45 |
| H | 1.80 | 2.20 |
| J | 0 | 0.10 |
| K | 0.90 | 1.00 |
| L | 0.25 | 0.40 |
| M | 0.10 | 0.22 |
| α | 0° | 8° |
| All Dimensions in mm | | |

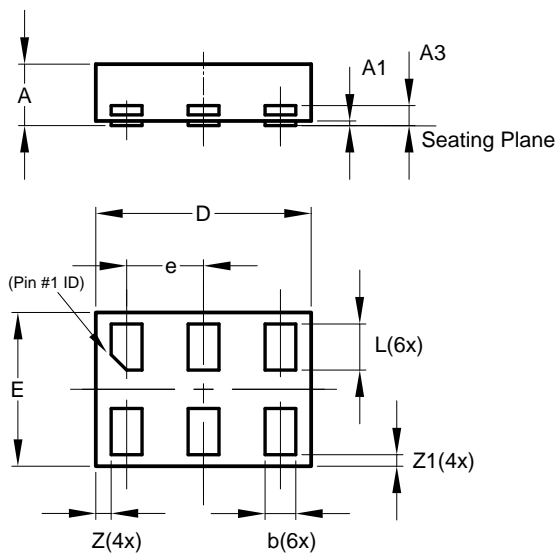
Package Outline Dimensions (All Dimensions in mm)

(3) X2-DFN1010-6



| X2-DFN1010-6 | | | |
|----------------------|------|------|-------|
| Dim | Min | Max | Typ |
| A | — | 0.40 | 0.39 |
| A1 | 0.00 | 0.05 | 0.02 |
| A3 | — | — | 0.13 |
| b | 0.14 | 0.20 | 0.17 |
| b1 | 0.05 | 0.15 | 0.10 |
| D | 0.95 | 1.05 | 1.00 |
| E | 0.95 | 1.05 | 1.00 |
| e | — | — | 0.35 |
| L | 0.35 | 0.45 | 0.40 |
| K | 0.15 | — | — |
| Z | — | — | 0.065 |
| All Dimensions in mm | | | |

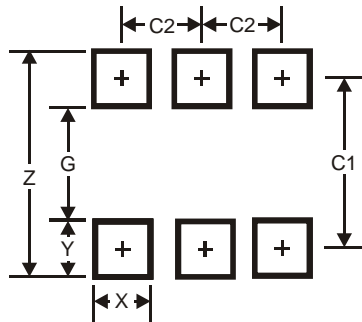
(4) X2-DFN1410-6



| X2-DFN1410-6 | | | |
|----------------------|-------|-------|-------|
| Dim | Min | Max | Typ |
| A | — | 0.40 | 0.39 |
| A1 | 0.00 | 0.05 | 0.02 |
| A3 | — | — | 0.13 |
| b | 0.15 | 0.25 | 0.20 |
| D | 1.35 | 1.45 | 1.40 |
| E | 0.95 | 1.05 | 1.00 |
| e | — | — | 0.50 |
| L | 0.25 | 0.35 | 0.30 |
| Z | — | — | 0.10 |
| Z1 | 0.045 | 0.105 | 0.075 |
| All Dimensions in mm | | | |

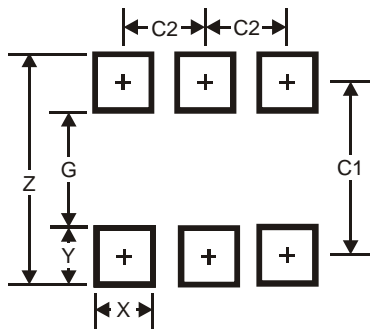
Suggest Pad Layout

(1) SOT26



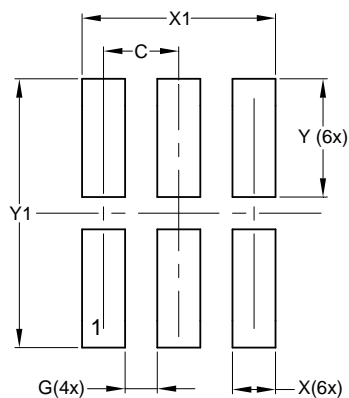
| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 3.20 |
| G | 1.60 |
| X | 0.55 |
| Y | 0.80 |
| C1 | 2.40 |
| C2 | 0.95 |

(2) SOT363



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.5 |
| G | 1.3 |
| X | 0.42 |
| Y | 0.6 |
| C1 | 1.9 |
| C2 | 0.65 |

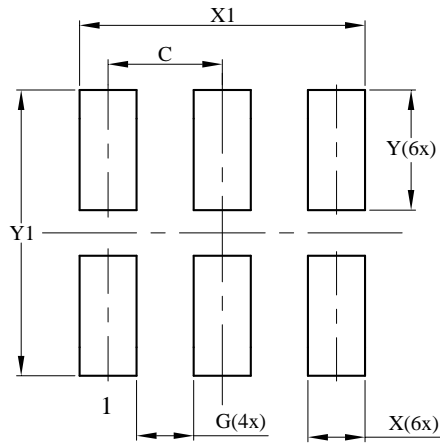
(3) X2-DFN1010-6



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 0.350 |
| G | 0.150 |
| X | 0.200 |
| X1 | 0.900 |
| Y | 0.550 |
| Y1 | 1.250 |

Suggest Pad Layout

(4) X2-DFN1410-6



| Dimensions | Value (in mm) |
|------------|------------------|
| C | 0.500 |
| G | 0.250 |
| X | 0.250 |
| X1 | 1.250 |
| Y | 0.525 |
| Y1 | 1.250 |

IMPORTANT NOTICE

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